# **Silicon Power Transistors**

The MJW21193 and MJW21194 utilize Perforated Emitter technology and are specifically designed for high power audio output, disk head positioners and linear applications.

#### **Features**

- Total Harmonic Distortion Characterized
- High DC Current Gain
- Excellent Gain Linearity
- High SOA
- These Devices are Pb-Free and are RoHS Compliant

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	250	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	400	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5.0	Vdc
Collector-Emitter Voltage - 1.5 V	V <sub>CEX</sub>	400	Vdc
Collector Current - Continuous	I <sub>C</sub>	16	Adc
Collector Current - Peak (Note 1)	I <sub>CM</sub>	30	Adc
Base Current - Continuous	I <sub>B</sub>	5.0	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate Above 25°C	P <sub>D</sub>	200 1.43	W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5 μs, Duty Cycle ≤ 10%.

#### THERMAL CHARACTERISTICS

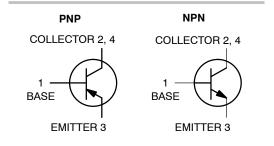
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.7	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W



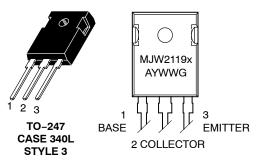
#### ON Semiconductor®

http://onsemi.com

# 16 AMPERES **COMPLEMENTARY SILICON POWER TRANSISTORS 250 VOLTS, 200 WATTS**



#### **MARKING DIAGRAM**



= 3 or 4

= Assembly Location

= Year

WW = Work Week = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
MJW21193G	TO-247 (Pb-Free)	30 Units/Rail
MJW21194G	TO-247 (Pb-Free)	30 Units/Rail

#### FI FCTRICAL CHARACTERISTICS (To = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•	•	•
Collector–Emitter Sustaining Voltage ( $I_C = 100 \text{ mAdc}, I_B = 0$ )	V <sub>CEO(sus)</sub>	250	_	-	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 200 Vdc, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	_	100	μAdc
Emitter Cutoff Current (V <sub>CE</sub> = 5 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	-	_	100	μAdc
Collector Cutoff Current (V <sub>CE</sub> = 250 Vdc, V <sub>BE(off)</sub> = 1.5 Vdc)	I <sub>CEX</sub>	-	_	100	μAdc
SECOND BREAKDOWN					
Second Breakdown Collector Current with Base Forward Biased (V <sub>CE</sub> = 50 Vdc, t = 1 s (non-repetitive) (V <sub>CE</sub> = 80 Vdc, t = 1 s (non-repetitive)	I <sub>S/b</sub>	4.0 2.25	_ _	- -	Adc
ON CHARACTERISTICS	<u>'</u>				11
DC Current Gain ( $I_C = 8$ Adc, $V_{CE} = 5$ Vdc) ( $I_C = 16$ Adc, $I_B = 5$ Adc)	h <sub>FE</sub>	20 8	_ _	80 -	
Base-Emitter On Voltage (I <sub>C</sub> = 8 Adc, V <sub>CE</sub> = 5 Vdc)	V <sub>BE(on)</sub>	-	_	2.2	Vdc
Collector–Emitter Saturation Voltage ( $I_C = 8$ Adc, $I_B = 0.8$ Adc) ( $I_C = 16$ Adc, $I_B = 3.2$ Adc)	V <sub>CE(sat)</sub>	- -	- -	1.4 4	Vdc
DYNAMIC CHARACTERISTICS					
Total Harmonic Distortion at the Output  V <sub>RMS</sub> = 28.3 V, f = 1 kHz, P <sub>LOAD</sub> = 100 W <sub>RMS</sub> h <sub>FE</sub>	T <sub>HD</sub>		0.0		%
		-	0.8	_	
Current Gain Bandwidth Product (I <sub>C</sub> = 1 Adc, V <sub>CE</sub> = 10 Vdc, f <sub>test</sub> = 1 MHz)	f <sub>T</sub>	4	_	-	MHz
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f <sub>test</sub> = 1 MHz)	C <sub>ob</sub>	-	_	500	pF

# $V_{CE} = 10 \text{ V}$

 $f_{\rm T}$ , CURRENT GAIN BANDWIDTH PRODUCT (MHz) 6.0 5.5 5.0 4.5 4.0  $T_J = 25^{\circ}C$ f<sub>test</sub> = 1 MHz 1.0 10 I<sub>C</sub> COLLECTOR CURRENT (AMPS)

**PNP MJW21193** 

Figure 1. Typical Current Gain Bandwidth Product

#### **NPN MJW21194** $f_{\rm T}$ , CURRENT GAIN BANDWIDTH PRODUCT (MHz) 8.0 7.0 6.0 5.0 V<sub>CE</sub> = 5 4.0 3.0 2.0 $T_J = 25^{\circ}C$ 1.0 f<sub>test</sub> = 1 MHz 1.0 10 I<sub>C</sub> COLLECTOR CURRENT (AMPS)

Figure 2. Typical Current Gain Bandwidth Product

#### **TYPICAL CHARACTERISTICS**

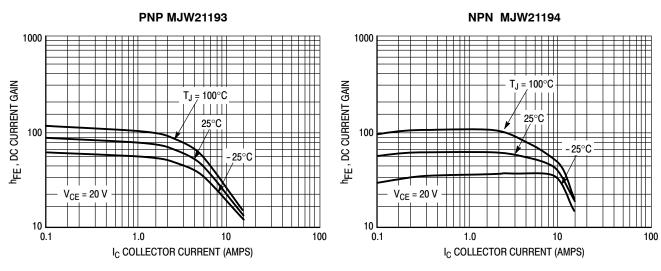


Figure 3. DC Current Gain, V<sub>CE</sub> = 20 V

Figure 4. DC Current Gain, V<sub>CE</sub> = 20 V

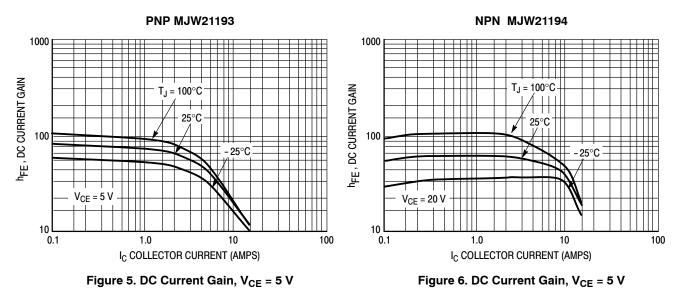


Figure 5. DC Current Gain, V<sub>CE</sub> = 5 V

**PNP MJW21193 NPN MJW21194** 30 35 I<sub>B</sub> = 2 A 1.5 A  $I_B = 2 A$ 30 25 I<sub>C</sub>, COLLECTOR CURRENT (A) <sub>(C</sub>, COLLECTOR CURRENT (A) 1.5 A 25 20 1 A 1 A 20 15 0.5 A 15 0.5 A 10 10 5.0  $T_J=25^{\circ}C$  $T_J = 25^{\circ}C$ 0 0 25 15 0 5.0 25 V<sub>CE</sub>, COLLECTOR-EMITTER VOLTAGE (VOLTS) V<sub>CE</sub>, COLLECTOR-EMITTER VOLTAGE (VOLTS)

Figure 7. Typical Output Characteristics

Figure 8. Typical Output Characteristics

#### **TYPICAL CHARACTERISTICS**

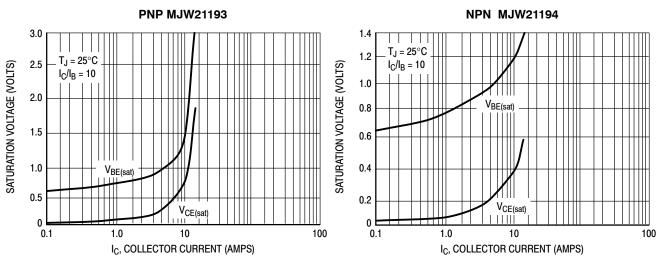


Figure 9. Typical Saturation Voltages

Figure 10. Typical Saturation Voltages

100

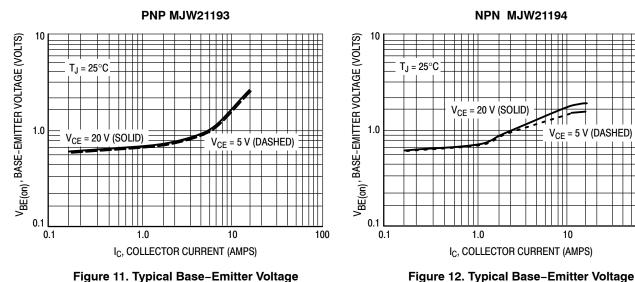


Figure 11. Typical Base-Emitter Voltage

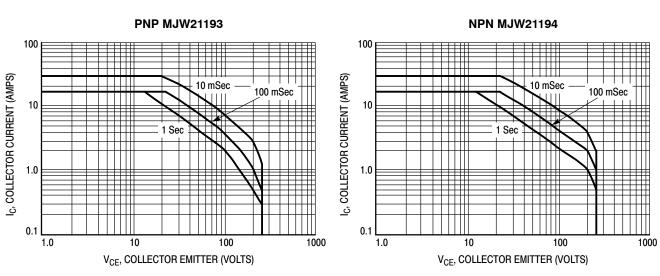
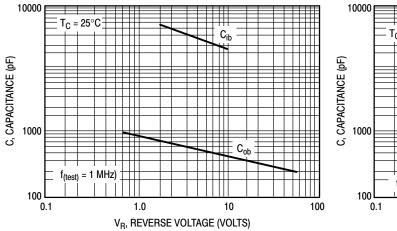


Figure 13. Active Region Safe Operating Area

Figure 14. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate  $I_C$  –  $V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 13 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_{C}$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.



10000

T<sub>C</sub> = 25°C

T<sub>C</sub> = 25°C

C<sub>ib</sub>

1000

T<sub>(lest)</sub> = 1 MHz)

100

V<sub>B</sub>, REVERSE VOLTAGE (VOLTS)

Figure 15. MJW21193 Typical Capacitance

Figure 16. MJW21194 Typical Capacitance

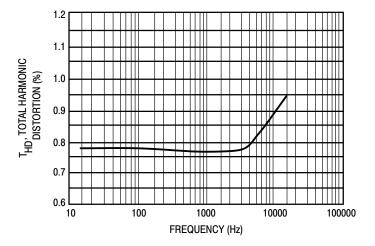


Figure 17. Typical Total Harmonic Distortion

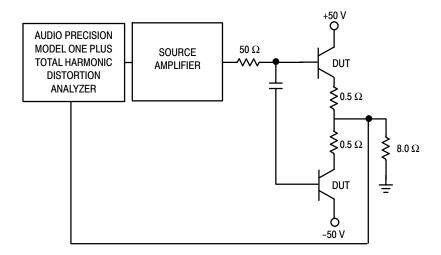
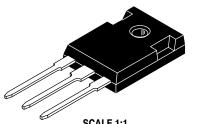
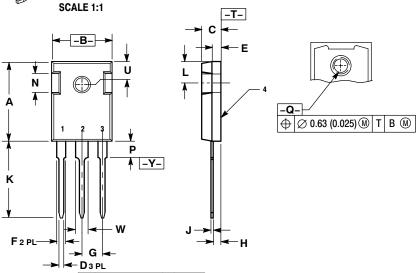


Figure 18. Total Harmonic Distortion Test Circuit



TO-247 CASE 340L-02 ISSUE F

**DATE 26 OCT 2011** 



STYLE 2: PIN 1. ANODE 2. CATHODE (S) STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR STYLE 1: PIN 1. GATE 2. DRAIN STYLE 3: PIN 1. BASE 2. COLLECTOR 3. SOURCE 4. DRAIN 3. ANODE 2 4. CATHODES (S) 3. EMITTER 4. COLLECTOR STYLE 5: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE STYLE 6: PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

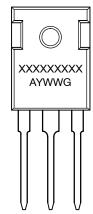
3. GATE 4. MAIN TERMINAL 2

⊕ 0.25 (0.010) M Y Q S

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	20.32	21.08	0.800	8.30
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Е	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
K	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
P		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC 0.242 BSC		BSC	
W	2.87	3.12	0.113	0.123

#### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

Υ = Year WW = Work Week = Pb-Free Package G

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DOCUMENT NUMBER:	98ASB15080C	Electronic versions are uncontrolled except wh		
STATUS:	ON SEMICONDUCTOR STANDARD	accessed directly from the Document Repository. Priversions are uncontrolled except when stamped	, ,	
NEW STANDARD:		"CONTROLLED COPY" in red.		
DESCRIPTION:	TO-247	PAGE 1 OI	F 2	



<b>DOCUMENT</b>	NUMBER:
98ASB15080	C

PAGE 2 OF 2

ISSUE	REVISION	DATE
D	CHANGE OF OWNERSHIP FROM MOTOROLA TO ON SEMICONDUCTOR. DIM A WAS 20.80-21.46/0.819-0.845. DIM K WAS 19.81-20.32/0.780-0.800. UPDATED STYLE 1, ADDED STYLES 2, 3, & 4. REQ. BY L. HAYES.	25 AUG 2000
E	DIM E MINIMUM WAS 2.20/0.087. DIM K MINIMUM WAS 20.06/0.790. ADDED GENERIC MARKING DIAGRAM. REQ. BY S. ALLEN.	26 FEB 2010
F	ADDED STYLES 5 AND 6. REQ. BY J. PEREZ.	26 OCT 2011

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

© Semiconductor Components Industries, LLC, 2011 October, 2011 - Rev. 02F 340L

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent\_Marking.pdf">www.onsemi.com/site/pdf/Patent\_Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Sh

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative